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Sound Processors for BOOM BOX / Mini-component Stereo





Single Power Supply Sound Processors with Built-in Pre Amplifier for Tape Recording and Play Back (With Integrated 2-/3- band Equalizer)

BD3401KS2,BD3402KS2

No.10086EAT03

Description

The Sound Processor with built-in record/play functions for cassette players, is suited for sound quality products such as, BOOM BOX, mini- and micro-audio systems. It incorporates various functions ranging from audio source selectors to preamplifiers at the front stage, preamplifier for cassette recording/playing, and a 2-wire serial bus.

Features

- 1) Provides Surround and Bass Boost with the Soft-switching feature to reduce the shock sound at switching (BD3401KS2)
- Provides a specialized power supply terminal in a digital circuit, in order to set and maintain the state inside the IC by the minute stand-by current.
- 3) Built-in preamplifier for cassette recording/playing allows for minimal external components, freeing up board space.
- 4) Arranges all I/O terminals to a single point and allows easy PCB routing.
- 5) Volume and Tone implemented with a resistance ladder circuit; achieving high performance with low noise and low distortion
- Energy-saving design resulting in low current consumption, by utilizing the BiCMOS process. It has the advantage in quality over the scaling down the power heat control of the internal regulators.

Applications

BOOM BOX, mini-audio systems, and micro-audio systems.

Product lineup

Parameter	BD3401KS2	BD3402KS2		
Equalizer	3 band(BASS, MIDDLE, TREBLE)	2 band(BASS, TREBLE)		
Volume	0 to -44dB/2dB step -44 to -76dB/4dB step, -∞dB	0 to -44dB/2dB step -44 to -76dB/4dB step, -∞dB		
Cassette Recording/Playing Amplifier	0	0		
Karaoke	0	-		
Microphone Input	0	-		
Subwoofer Output	0	-		
Output for Spectrum Analyzer	0	-		
Surround	0	-		
Bass Boost	0	-		
Package	SQFP-T64	SQFP-T64		

Absolute maximum ratings (Ta=25°C)

Items	Symbol	Ratings	Unit
Dower Cumply Voltage	Vcc	10	V
Power Supply Voltage	Vdd	6	V
Power Dissipation	Pd	1200*	mW
Input Voltage Range	Vin	GND-0.3 to VCC+0.3	V
Operating Temperature Range	Topr	-25 to +75	°C
Storage Temperature Range	Tstg	-55 to +125	°C

Reduced by 12 mW/°C over 25°C, when installed on the standard board (size: 70 × 70 × 1.6mm).

Operating voltage range

Device Name	Symbol	Range	Unit
BD3401KS2	Vcc	8 to 9.5	V
BD3402KS2	Vdd	3 to 5.5	V

Electrical characteristics

⊙BD3401KS2

 $Ta=25\,^{\circ}C\;,\;\;VCC=9V\;,\;\;VDD=5V\;,\;\;f=1kHz,\;\;Vi=1Vrms, RL=10k\Omega, Rg=600\Omega\;,\;\;INPUT\;\;SELECTOR=Ach,\;\;INPUT\;\;GAIN=0dB,\;\;VOLUME=0dB\;,\;\;TREBLE=0dB\;,\;\;BASS=0dB\;,\;\;MIDDLE=0dB\;,\;\;TONE\;\;ATT=0dB\;,\;\;MUX=STEREO\;,\;\;MIXING=OFF\;,\;\;MIXING\;GAIN=0dB\;,\;\;PLAY\;BACK=TAPE\;A\;,\;\;REC=OFF\;,\;\;LINE=OFF\;,\;\;MIC=OFF\;,\;\;BASS\;BOOST=OFF\;,\;\;SURROUND=OFF\;,\;\;AMS=OFF\;,\;\;MIC=OFF\;,\;MIC=OFF\;,$

ALC=OFF, INPUT=pin59,60, OUTPUT=pin32,33, unless otherwise noted.

	S=OFF, INPUT=pin59,60, OUTPUT			Limits			Conditions
	Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
	Circuit Current	IQ	-	35	50	mA	(No signal)
	Output Voltage Gain	Gv	-2	0	2	dB	INPUT GAIN=0dB
	Total Harmonic Distortion ratio	THDt	-	0.005	0.05	%	BW=400 to 30kHz OUT=pin32,33,53,54
	Maximum Output Voltage	Vomaxt	2.0	2.5	_	Vrms	THD=1%, BW=400 to 30kHz OUT=pin32,33,53,54
TOTAL	Residual Noise Voltage*	Vr	-	1.8	6.0	μVrms	Rg=0Ω, Vol=-∞dB, BW=IHF-A,
	Output Noise Voltage*	Vno	-	3.0	9.0	μVrms	Rg=0Ω, Vol=0dB BW=IHF-A
	Cross-talk between Channels*	СТС	-	-80	-70	dB	Rg=0Ω, BW=IHF-A VOLOUT=1Vrms
	Cross-talk between Selectors*	CTS	-	-80	-70	dB	Rg=0Ω, BW=IHF-A
	Input Impedance	Rin	32	47	62	kΩ	Pin1 to 4, 59 to 64
MIXING	Total Harmonic Distortion ratio	THDmix	-	0.01	0.1	%	BW=400 to 30kHz, MIXING=ON INPUT SELECTOR=B
XIW	Maximum Output Voltage	Vomaxmix	2.0	2.5	_	Vrms	THD=1%, BW=400 to 30kHz MIXING=ON INPUT SELECTOR=B
	Output Voltage Gain	Gvp	23	25	27	dB	Vi=20mVrms, pin5-6, 7-8=short IN=pin9,10 OUT=pin6,7
X	Total Harmonic Distortion ratio	THDp	-	0.01	0.1	%	Vi=20mVrms BW=400 to 30kHz pin5-6, 7-8=short IN=pin9,10 OUT=pin6,7
PLAYBACK	Maximum Output Voltage	Vomaxp	2.0	2.5	_	Vrms	THD=1%, BW=400 to 30kHz pin5-6, 7-8=short IN=pin9,10 OUT=pin6,7
<u> </u>	Noise Voltage in input term*	Vnin	_	0.7	6.0	μVrms	Rg=0Ω,BW=IHF-A pin5-6, 7-8=short IN=pin9,10 OUT=pin6,7
	PB MUTE Amount	РВМ	-	_	-70	dB	BW=IHF-A, pin5-6, 7-8=short IN=pin9,10 PLAY BACK=MUTE
	ALC Operation Level	ALC	0.5	0.7	0.9	Vrms	REC=ON ALC=ON
REC	Total Harmonic Distortion ratio	THDr	-	0.2	1	%	BW=400 to 30kHz OUT=pin14,15 REC=ON ALC=ON
	Output Noise Voltage*	Vnor	_	40	120	μVrms	Rg=0Ω, BW=IHF-A OUT=pin14,15 REC=ON ALC=ON

				Limits			
	Parameter	Symbol	Min	Тур.	Max	Unit	Conditions
MIC	Total Harmonic Distortion ratio	THDmic	-	0.01	0.1	%	BW=400 to 30kHz MIC=ON
×	Maximum Output Voltage	V _{omaxmic}	2.0	2.5	_	Vrms	THD=1%, BW=400 to 30kHz MIC=ON
SPECTRUM ANALYZER	Spectrum Analyzer 1 Output Voltage Gain	Gvs1	-8	-6	-4	dB	OUTPUT=pin55
	Spectrum Analyzer 2 Output Voltage Gain	Gvs2	-2	0	2	dB	OUTPUT=pin56
SURRO	Surround Gain	Gsur	4	6	8	dB	SURROUND=ON Vi=500mVrms
TREBLE			dB	Vi=500mVrms			
TRE	Treble Gain Setting Error	TE	-2	0	2	dB	
MIDDLE	Middle Gain		-8 to +8(2dB/step)		dB	Vi=500mVrms	
MID	Middle Gain Setting Error	ME	-2	0	-2	dB	
BASS	Bass Gain	Gb	-8 to	+8(2dB	/step)	dB	Vi=500mVrms
BA	Bass Gain Setting Error	BE	-2	0	-2	dB	
AMS	AMS EQ Gain	Gams	33	35	37	dB	OUTPUT=pin40 AMS=ON, Vi=20mVrms
	Volume Setting Error 1	VE1	-2	0	2	dB	0 to -48dB,BW=IHF-A VOLOUT=1Vrms
VOLUME	Volume Setting Error 2	VE2	-3	0	3	dB	-52 to -76dB,BW=IHF-A VOLOUT=1Vrms
	Maximum Attenuation*	Vmin	_	-	-90	dB	BW=IHF-A VOLOUT=1Vrms
OOFER	Total Harmonic Distortion ratio	THDs	-	0.01	0.1	%	Vi=500mVrms BW=400 to 30kHz,OUT=pin25 No LPF
SUBWOOFER	Maximum Output Voltage	Vomaxs	1.5	2.0	2.5	Vrms	THD=3%, BW=400 to 30kHz OUT=pin25, No LPF

⊙BD3402KS2

 $Ta=25^{\circ}C,\ VCC=9V,\ VDD=5V,\ f=1kHz,\ Vi=1Vrms,\ RL=10k\Omega,\ Rg=600\,\Omega,INPUT\ SELECTOR=Ach,\ INPUT\ GAIN=0dB,\ VOLUME=0dB,\ TREBLE=0dB,\ BASS=0dB,\ TONE\ ATT=0dB,\ MUX=STEREO,\ MIXING=OFF,\ MIXING\ GAIN=0dB,\ REC=OFF,\ LINE=OFF,\ ALC=OFF\ INPUT=pin59,60,\ OUTPUT=pin32,33,\ unless\ otherwise\ noted.$

Circuit Current IQ - 28 50 mA (No signal)		C=OFF, LINE=OFF, ALC=OFF INF	<u>с.</u> рос,с	<u>, , , , , , , , , , , , , , , , , , , </u>	Limits	,,		
Output Voltage Gain Gv -2 0 2 dB INPUT GAIN=0dB		Parameter	Symbol	Min.	1	Max.	Unit	Conditions
Total Harmonic Distortion ratio THDt - 0.005 0.05		Circuit Current	Ŋ	-	28	50	mA	(No signal)
Maximum Output Voltage Vomaxt 2.0 2.5 - Vrms Vimbor Voltage Vomaxt Voltage V		Output Voltage Gain	Gv	-2	0	2	dB	INPUT GAIN=0dB
Maximum Output Voltage Voltage		Total Harmonic Distortion ratio	THDt	-	0.005	0.05	%	OUT=pin32,33,53,54
Output Noise Voltage*	7	Maximum Output Voltage	Vomaxt	2.0	2.5	-	Vrms	OUT=pin32,33,53,54
Cross-talk between Channels* CTC 80 -70 dB Rg=0Ω, BW=IHF-A VOLOUT=1/vms VO	TOT/	•	Vr	-		5.0	•	BW=IHF-A,
Cross-talk between Channels Cross-talk between Selectors* CTS 80 -70 dB Rg=0.9, Ew=IHF-A		Output Noise Voltage*	Vno	-	2.5	8.0	μVrms	
Input Impedance Rin 32 47 62 kΩ Pin1 to 4, 59 to 64				-				VOLOUT=1Vrms
Total Harmonic Distortion ratio THDmix -		Cross-talk between Selectors*	CTS	_	-80	-70	dB	Rg=0Ω, BW=IHF-A
Total Harmonic Distortion ratio THDmix -		Input Impedance	Rin	32	47	62	kΩ	Pin1 to 4, 59 to 64
Output Voltage Gain Gvp 23 25 27 dB NPUT SELECTOR=B	SING	Total Harmonic Distortion ratio	THDmix	_	0.01	0.1	%	MIXING=ON INPUT SELECTOR=B
Output Voltage Gain Gvp 23 25 27 dB pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7	ž	Maximum Output Voltage	Vomaxmix	2.0	2.5	-	Vrms	MIXING=ON INPUT SELECTOR=B
Total Harmonic Distortion ratio THDp - 0.01 0.1 % pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7		Output Voltage Gain	Gvp	23	25	27	dB	pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7
Noise Voltage in input term* Vnin - 0.7 6.0 μVrms pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7	X		THDp	-	0.01	0.1	%	pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7
Noise Voltage in input term* Vnin - 0.7 6.0 μVrms pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7	_AYBA(Vomaxp	2.0	2.5	-	Vrms	pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7
PB MUTE Amount PBM - - -70 dB IN=pin11,12 PLAY BACK=MUTE	₫	Noise Voltage in input term*	Vnin	-	0.7	6.0	μVrms	pin5-6, 7-8=short IN=pin11,12 OUT=pin6,7
Total Harmonic Distortion ratio		PB MUTE Amount	PBM	-	_	-70	dB	IN=pin11,12
Total Harmonic Distortion ratio		ALC Operation Level	ALC	0.5	0.7	0.9	Vrms	
Output Noise Voltage* Vnor - 40 120 µVrms Rg=0 \(\Omega \), BW=IHF-A OUT=pin14,15 REC=ON, ALC=ON Treble Gain Gt -8 to +8(2dB/step) dB Vi=500mVrms Treble Gain Setting Error TE -2 0 2 dB Sylvant Bass Gain Gb -12 to +12(3dB/step) dB Vi=500mVrms	SEC	Total Harmonic Distortion ratio	THDr	_	0.2	1	%	OUT=pin14,15 REC=ON, ALC=ON
Bass Gain Gb -12 to +12(3dB/step) dB Vi=500mVrms	_	Output Noise Voltage*	Vnor	-	40	120	μVrms	OUT=pin14,15
Bass Gain Gb -12 to +12(3dB/step) dB Vi=500mVrms	BLE	Treble Gain	Gt	-8 to	+8(2dB/	step)	dB	Vi=500mVrms
Bass Gain Gb -12 to +12(3dB/step) dB Vi=500mVrms	IRE	Treble Gain Setting Error	TE	-2	0	2	dB	
	BASS	Bass Gain	Gb			dB	Vi=500mVrms	
	BASS	Bass Gain Setting Error	BE	-2	0	-2	dB	
Well and the Setting Error 1 VE1 -2 0 2 dB 0 to -48dB,BW=IHF-A VOLOUT=1Vrms	ME	Volume Setting Error 1	VE1	-2	0	2	dB	VOLOUT=1Vrms
Volume Setting Error 1	/OLU			-3	0			VOLOUT=1Vrms
Maximum Attenuation* Vmin90 dB BW=IHF-A VOLOUT=1Vrms	>			_	_			BW=IHF-A VOLOUT=1Vrms

[•] For measurements marked with *, VP-9690A (Average value wave detection, Effective value display) filter by Matsushita Communication Industrial is used.

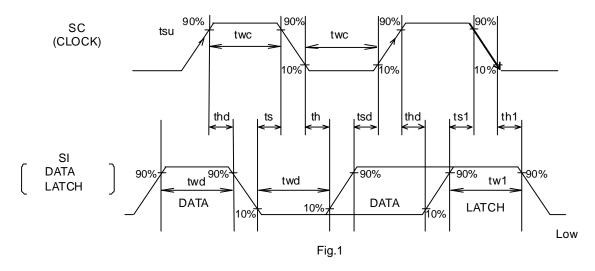
[•] Phase relation between Input/Output signal terminals is the same (Inputs: pin59-64, pin1-4, Outputs: pin32, 33).

[•] This IC is not designed to be radiation-resistant.

● Control signal specifications

- 1. Signal Timing Conditions
 - Data is read on the rising edge of the clock.
 - · Latch is read on the falling edge of the clock.
 - · Latch signal must terminate with the LOW state.
 - To avoid malfunctions, clock and data signals must terminate with the LOW state.

1byte=8bit



Parameter	Symbol			Unit	
Farameter	Symbol	Min	Тур.	Max	Utill
Minimum Clock Width	twc	2.0	_	_	μS
Minimum Data Width	twd	2.0	_	_	μS
Minimum Latch Width	tw1	2.0	_	_	μS
Data Set-up Time (DATA→CLK)	tsd	1.0	_	_	μS
Data Hold Time (CLK→DATA)	thd	1.0	-	_	μS
Latch Set-up Time (CLK→LATCH)	ts1	1.0	-	-	μS
Latch Hold Time (DATA→LATCH)	th1	1.0	_	_	μS
Latch Low Set-up Time	ts	1.0	_	_	μS
Latch Low Hold Time	th	1.0	-	-	μS

2. Voltage Conditions for Control Signals

Parameter	Symbol		Unit			
Farameter	Symbol	Min	Тур	Max	Offic	
"H" Input Voltage	Vcc=8 to 9.5V	2.2	_	5.5	V	
"L" Input Voltage	Vcc=8 to 9.5V	0	-	1.0	V	

●Control data format list

(BD3401KS2)

• Basic Configuration of Control Data Format

←Data input direction

	MSB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
Data			Data			S	elect Addres	S

· Control Data Formats

←Data input direction

←Data input direction									
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(1)	I	nput Selecto	r	Input	Gain	0	0	0	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(2)			Volume			0	0	1	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(3)		Tre	eble		TONE ATT(1)	0	1	0	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(4)		Ва	ISS		TONE ATT(2)	0	1	1	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(5)		Mic	idle		0	1	0	0	
	D7	D6	D5	D4	D3				
Data(6)		Subwoo	fer Gain		1	1	0	0	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(7)	M	UX	MIXING	MIXING	G GAIN	1	0	1	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(8)	PLAY BACK REC LINE				MIC	1	1	0	
	D7	D6	D5	D4	D3	D2	D1	D0	
Data(9)	Bass Boost	Surround	AMS	ALC	Vocal Fader	1	1	1	

(BD3402KS2)

· Basic Configuration of Control Data Format

← Data input direction

· Data Input	anoonon	=						
	MSB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
Data	D7		Data			S	Select Addres	S

· Control Data Formats

← Data input direction

— Data input direction										
	D7	D6	D5	D4	D3	D2	D1	D0		
Data(1)	Gain	0	0	0						
	D7	D6	D5	D4	D3	D2	D1	D0		
Data(2)			Volume			0	0	1		
Data(3)	D7	D6	D5	D4	D3	D2	D1	D0		
		Tre	eble		TONE ATT(1)	0	1	0		
	D7	D6	D5	D4	D3	D2	D1	D0		
Data(4)		Ва	ass		TONE ATT(2)	0	1	1		
	D7	D6	D5	D4	D3	D2	D1	D0		
Data(5)	MUX MIXING MIXING				G GAIN	1	0	1		
	D7	D6	D5	D4	D3	D2	D1	D0		
Data(6)	* REC			LINE	ALC	1	1	0		
- 4 Indiantan O										

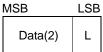
^{• *} Indicates 0 or 1.

- By changing the setting of Select Address, nine different control formats are selectable.
- In every power-on sequence, all of the address data must be initialized. Example:
 - ← Data input direction

1	MSB	LSB	MSB	LSB	MSB	LSB	MSB	LSB	MSB	LSB	}
	Data(1)	L	Data(2)	L	Data(3)	L	Data(4)	L	 Data(9)	L	

[&]quot;L" means a "latch."

- After power-on, for the second and subsequent times, only the necessary data can be selected for setting. Example: When changing the volume,
 - ← Data input direction



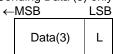
"L" means a "latch."

TONE ATT settings

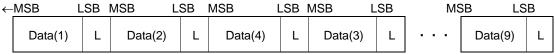
TONE ATT can be set to either one of three modes: 0dB, -4dB and -8dB using D3 in Data (3) or Data (4). When setting TONE ATT, data should be sent as follows:

(1)TONE ATT=-4dB

(a) Sending Data (3) only



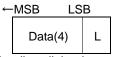
(b) Sending all the data



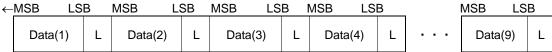
Sending Data(3) after Data(4) follows that Data(3) is given a higher priority.

(2)TONE ATT=-8dB

(a) Sending Data(4) only



(b) Sending all the data



Sending Data(4) after Data(3) follows that Data(4) is given a higher priority.

●Pin description (BD3401KS2)

(BD3401KS2)						
Pin No.	Pin Name	Description	Pin No.	Pin Name	Description	
1	D1	1ch input pin D	33	VOLOUT1	1ch output pin	
2	D2	2ch input pin D	34	BBNF1	1ch bass boost filter setting pin	
3	E1	1ch input pin E	35	BBIN1	1ch bass boost filter setting pin	
4	E2	2ch input pin E	36	VIN1	1ch volume input pin	
5	PBNF2	2ch PB filter setting pin	37	TONE OUT1	1ch tone output pin	
6	PBOUT2	2ch PB output pin	38	VIN2	2ch volume input pin	
7	PBOUT1	1ch PB output pin	39	TONE OUT2	2ch tone output pin	
8	PBNF1	1ch PB filter setting pin	40	AMS OUT	AMS output pin	
9	TAPE A1	1ch TAPE input pin A	41	BNF2	2ch bass filter setting pin	
10	TAPE A2	2ch TAPE input pin A	42	BOUT2	2ch bass filter setting pin	
11	TAPE B1	1ch TAPE input pin B	43	BOUT1	1ch bass filter setting pin	
12	TAPE B2	2ch TAPE input pin B	44	BNF1	1ch bass filter setting pin	
13	RECNF2	2ch REC filter setting pin	45	MNF1	1ch middle filter setting pin	
14	RECOUT2	2ch REC output pin	46	MOUT1	1ch middle filter setting pin	
15	RECOUT1	1ch REC output pin	47	MOUT2	2ch middle filter setting pin	
16	RECNF1	1ch REC filter setting pin	48	MNF2	2ch middle filter setting pin	
17	ALC	ALC time constant setting pin	49	TNF2	2ch treble filter setting pin	
18	SC	Serial clock input pin	50	TNF1	1ch treble filter setting pin	
19	SI	Serial data input pin	51	SUR1	Surround setting pin	
20	VDD	Digital power supply pin	52	SUR2	Surround setting pin	
21	GND	Ground pin	53	LINEOUT2	2chLINE output pin	
22	VCC	Analog power supply pin	54	LINEOUT1	1chLINE output pin	
23	1/2VCC	1/2VCC output pin	55	SAOUT2	Spectrum Analyzer output pin 2	
24	FILTER	1/2 VCC pin	56	SAOUT1	Spectrum Analyzer output pin 1	
25	SW OUT	Subwoofer output pin	57	CAP	Time constant setting pin for absorbing switching shock sound	
26	LF4	Primary LPF setting pin	58	MIC	MIC input pin A	
27	LF3	Secondary LPF setting pin	59	A1	1ch input pin A	
28	LF2	Secondary LPF setting pin	60	A2	2ch input pin A	
29	LF1	Secondary LPF setting pin	61	B1	1ch input pin B	
30	BBIN2	2ch bass boost filter setting pin	62	B2	2ch input pin B	
31	BBNF2	2ch bass boost filter setting pin	63	C1	1ch input pin C	
32	VOL OUT2	2ch output pin	64	C2	2ch input pin C	
		t contract to the contract to				

●Block diagram, application circuit, pin assignment

(BD3401KS2)

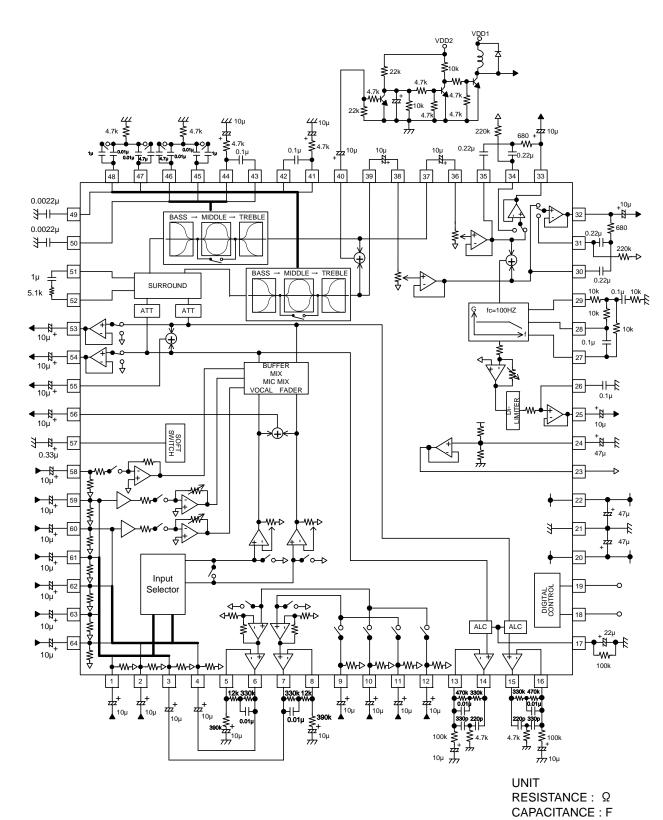


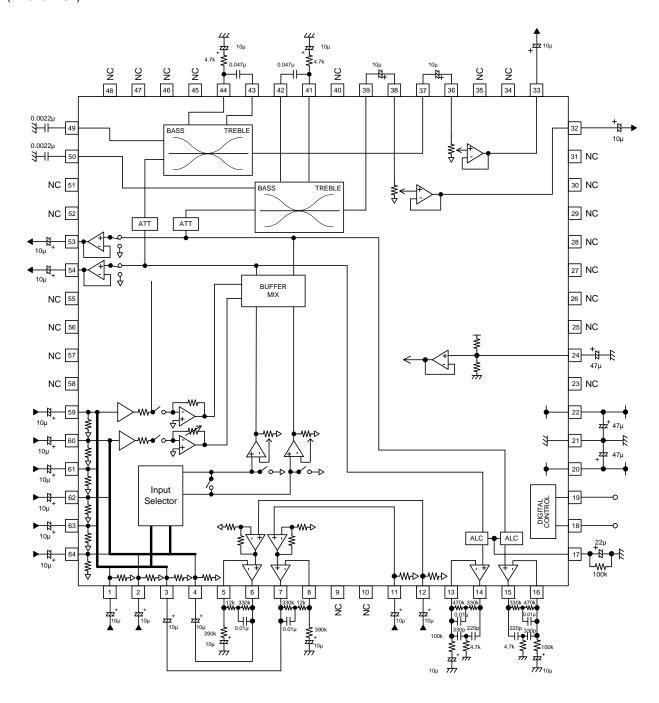
Fig.2

●Pin description (BD3402KS2)

(BD3402	KS2)				
Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	D1	1ch input pin D	33	VOL OUT1	1ch output pin
2	D2	2ch input pin D	34	NC	Non Connection
3	E1	1ch input pin E	35	NC	Non Connection
4	E2	2ch input pin E	36	VIN1	1ch volume input pin
5	PBNF2	2ch PB filter setting pin	37	TONE OUT1	1ch tone output pin
6	PBOUT2	2ch PB output pin	38	VIN2	2ch volume input pin
7	PBOUT1	1ch PB output pin	39	TONE OUT2	2ch tone output pin
8	PBNF1	1ch PB filter setting pin	40	NC	Non Connection
9	NC	Non Connection	41	BNF2	2ch bass filter setting pin
10	NC	Non Connection	42	BOUT2	2ch bass filter setting pin
11	TAPE 1	1ch TAPE input pin	43	BOUT1	1ch bass filter setting pin
12	TAPE 2	2ch TAPE input pin	44	BNF1	1ch bass filter setting pin
13	RECNF2	2ch REC filter setting pin	45	NC	Non Connection
14	RECOUT2	2ch REC output pin	46	NC	Non Connection
15	RECOUT1	1ch REC output pin	47	NC	Non Connection
16	RECNF1	1ch REC filter setting pin	48	NC	Non Connection
17	ALC	ALC time constant setting pin	49	TNF2	2ch treble filter setting pin
18	SC	Serial clock input pin	50	TNF1	1ch treble filter setting pin
19	SI	Serial data input pin	51	NC	Non Connection
20	VDD	Digital power supply pin	52	NC	Non Connection
21	GND	Ground pin	53	LINEOUT2	2chLINE output pin
22	VCC	Analog power supply pin	54	LINEOUT1	1chLINE output pin
23	NC	Non Connection	55	NC	Non Connection
24	FILTER	1/2 VCC pin	56	NC	Non Connection
25	NC	Non Connection	57	NC	Non Connection
26	NC	Non Connection	58	NC	Non Connection
27	NC	Non Connection	59	A1	1ch input pin A
28	NC	Non Connection	60	A2	2ch input pin A
29	NC	Non Connection	61	B1	1ch input pin B
30	NC	Non Connection	62	B2	2ch input pin B
31	NC	Non Connection	63	C1	1ch input pin C
32	VOL OUT2	2ch output pin	64	C2	2ch input pin C
		I.	1		

●Block diagram, application circuit, pin assignment

(BD3402KS2)



UNIT

 $\begin{array}{ll} \text{RESISTANCE}: \; \Omega \\ \text{CAPACITANCE}: \; \text{F} \end{array}$

Fig.3

●Reference data

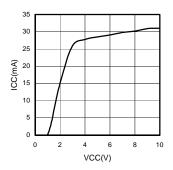


Fig.4 Circuit Current - Supply Voltage (BD3401KS2)

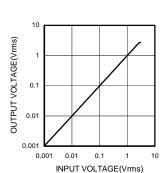


Fig.7 Output Voltage - Input Voltage

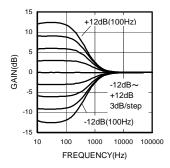


Fig.10 Bass Gain - Frequency (BD3402KS2)

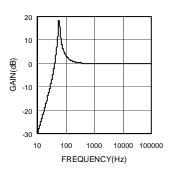


Fig.13 Bass Boost Gain - Frequency (BD3401KS2)

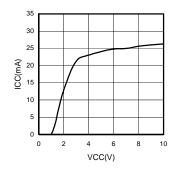


Fig.5 Circuit Current - Supply Voltage (BD3402KS2)

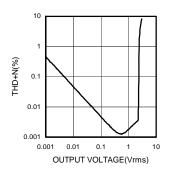


Fig.8 Total Harmonic Distortion ratio - Output Voltage

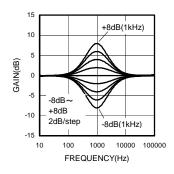


Fig.11 Middle Gain – Frequency (BD3401KS2)

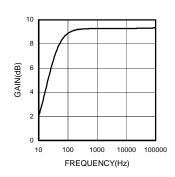


Fig.14 Surround Gain - Frequency (BD3401KS2)

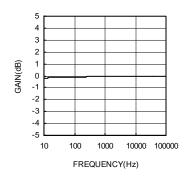


Fig.6 Voltage Gain - Frequency

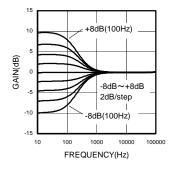


Fig.9 Bass Gain - Frequency (BD3401KS2)

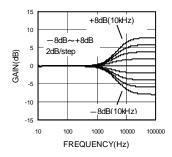


Fig.12 Treble Gain - Frequency

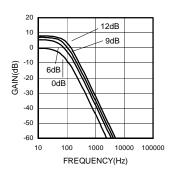


Fig.15 Subwoofer Gain - Frequency (BD3401KS2)

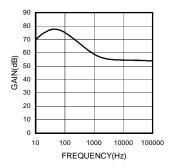


Fig.16 Amp Gain - Frequency (PB)

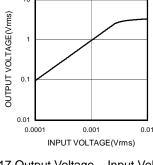


Fig.17 Output Voltage – Input Voltage (PB)

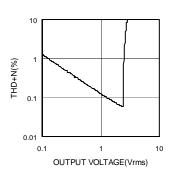


Fig.18 Total Harmonic Distortion ratio
- Output Voltage (PB)

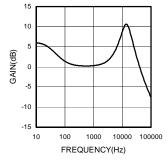


Fig.19 Amp Gain - Frequency (REC)

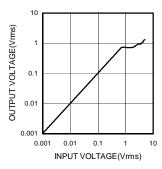


Fig.20 Output Voltage – Input Voltage (REC)

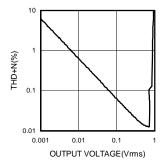


Fig.21Total Harmonic Distortion ratio
– Output Voltage (REC)

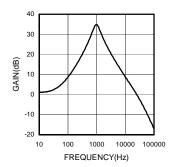


Fig.22 AMS Gain - Frequency (BD3401KS2)

Notes for use

- 1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2) Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.
- 3) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

4) GND potential

Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

5) Thermal design

Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.

6) Short circuit between terminals and erroneous mounting

Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.

7) Operation in strong electromagnetic field

Using the ICs in a strong electromagnetic field can cause operation malfunction.

8) Serial control

For the SC and SI terminals, the wiring and layout patterns should be routed as not to cause interference with the analog-signal-related lines.

9) Power ON/OFF

At power ON/OFF, a shock sound will be generated and, therefore, MUTE shall be applied.

10) Start-up sequence of the power supplies

VDD and VCC should be turned on simultaneously or VDD first, followed by VCC.

11) Function switching

(BD3401KS2)

For all functions except Master Volume, Treble, Middle, Bass, Surround, and Bass Boost, MUTE must be applied during setup.

(BD3402KS2)

For all the functions except Master Volume, Treble and Bass, MUTE must be applied during setup..

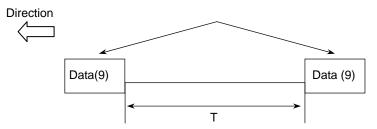
12) Power-ON Reset

A built-in circuit for performing initialization inside the IC at power-ON is provided. In unstable systems it is recommended that the data shall be sent to all the addresses during power-ON, until this operation cycle is completed. Mute should be applied during this cycle.

Function	Initial State	BD3401KS2	BD3402KS2
Input Selector	MUTE	0	0
Input Gain	-5dB	0	0
Volume	0dB	0	0
Treble	0dB	0	0
Bass	0dB	0	0
Middle	0dB	0	-
TONE ATT	0dB	0	0
Subwoofer	0dB	0	-
MUX	STEREO	0	0
Mixing	OFF	0	0
Mixing Gain	3dB	0	0
PLAY BACK	TAPE A	0	No selector
REC	OFF	0	0
LINE	OFF	0	0
MIC	OFF	0	-
Bass Boost	OFF	0	-
Surround	OFF	0	-
AMS	OFF	0	-
ALC	OFF	0	0
Vocal Fader	OFF	0	-

- 13) Constraints of serial control
 - (1) On soft-switching of the BASS BOOST, SURROUND and AMS functions, data must not be serially sent to the functions involved before the switching operation is completed. Data (1) to (8) can be serially sent immediately after sending Data (9).

For functions that need to use soft-switch, data (Data (9)) can be serially sent on the same select address.



The time interval: T(sec) between Data (9) must be set to have a sufficeient delay time. For example, 100ms or more when C on pin57 is $0.33\mu F$.

Fig.23

(2) When switching AMS ON and OFF, a shock sound will be generated.
Using MUTE provided on VOLUME, control data should be sent in order to avoid outputting the shock sound from VOLOUT1,2 (pin32,33) as described in the figure below:

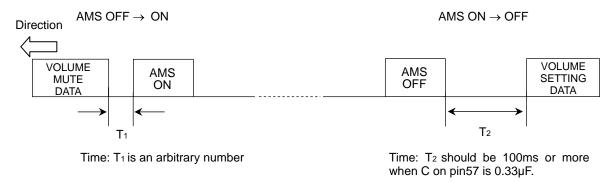
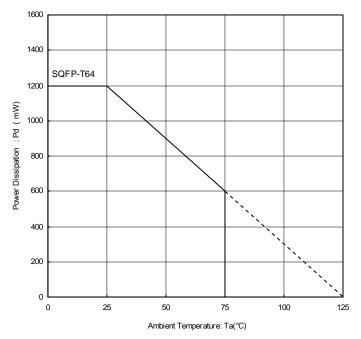


Fig.24

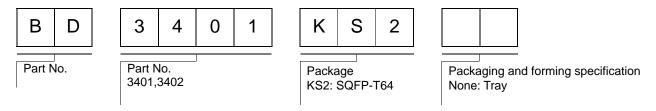
•Thermal derating characteristic



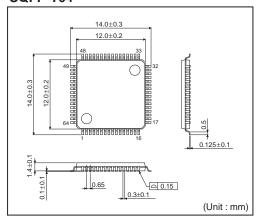
When installed on the ROHM standard board (size: $70 \times 70 \times 1.6$ mm, Glass epoxy board)

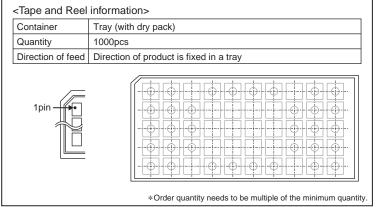
Fig.25

Ordering part number



SQFP-T64





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JAPAN	USA	EU	CHINA	
CLASSⅢ	CL ACCTI	CLASS II b	CLASSIII	
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSIII	

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

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 - [d] the Products are exposed to high Electrostatic
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